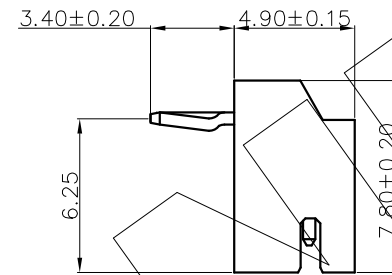
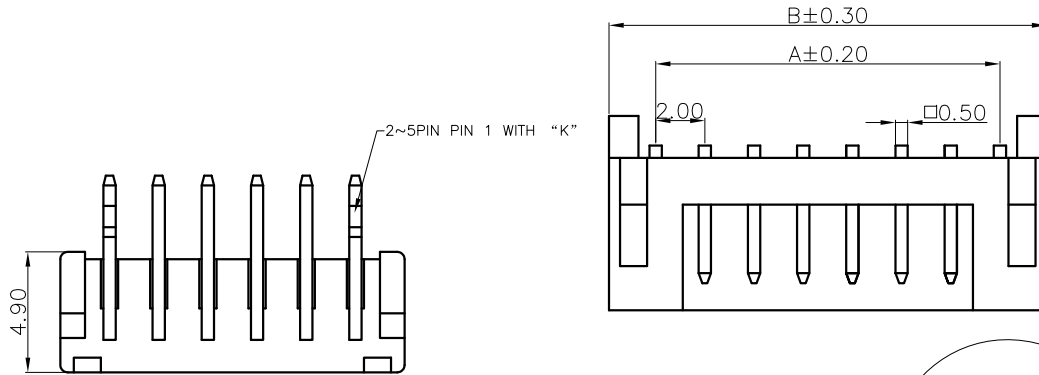


零件图	成品图	客户图
		○

REVISION DATA

REV	ECN No.	DESCRIPTION	NAME	DATE
A0		NEW DRAWING	Zhang	2017-09-25

poles	A	B
2	2.00	6.00
3	4.00	8.00
4	6.00	10.00
5	8.00	12.00
6	10.00	14.00
7	12.00	16.00
8	14.00	18.00
9	16.00	20.00
10	18.00	22.00
11	20.00	24.00
12	22.00	26.00
13	24.00	28.00
14	26.00	30.00
15	28.00	32.00
16	30.00	34.00

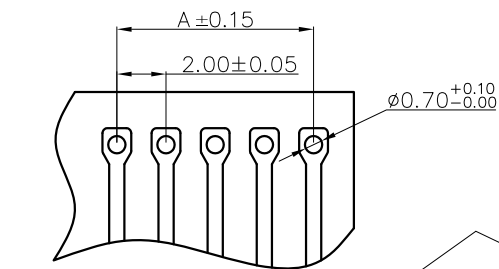


Technical Data

Material:
 Contact Material: Copper Alloy
 Contact plating: Au or Sn Over Ni
 Insulator Material: See the table, UL94 V-0

Electrical:
 Rating current: 2Amps/contact max.
 Rating voltage : 250 V AC/DC
 Contact resistance: ≤20mΩ/contact
 Insulation resistance: ≥1000MΩ
 Withstanding Voltage: 1000V AC/minute

Mechanical:
 Operating temperatures: Gold Plated: -55°C to +105°C
 Tin plated: -40°C to +105°C
 Soldering temperature: +260°C, max(PA66)
 +220°C, max(PBT)



Recommended P.B.C. Layout

WF	B	R	11	XXX	XX	X	N	R022
Pitch(mm) A 2.5 B 2.0 C 1.25 D 3.96 E 2.54 F 3.0 G 1.0 H 1.5	Angel Options R 90° D 180° S SMT	Product Type 11 Single row	No. of Positions XXX Poles	Pin Plating G0 Gold Flash SN Tin Plated	Insulator Material A PBT B PA66 C PA6T D LCP E PA46 F PA9T	W With peg N NO Peg L with lock T Fixed Tabs	Series NO.	

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东莞市恩康电子科技有限公司

DONGGUAN ENKANG ELECTRONICS TECHNOLOGY CO.,LTD

TOLERANCE	DATE : 2017-09-25	TITLE: PH 2.0 H4.90 90° DIP WAFER
ANGLE ±5°	DRAWN : Zhang	PART NO: WFBR11XXXXXXNR022
X.XXX ±0.15	CHECKED :	
X.XX ±0.25	APPROVED :	
X.X ±0.40	PROJECTON	REV: A0
X. ±0.50		UNIT: mm
		SCALE: 1:1
		SIZE: A4
		PAGE: 1/1